

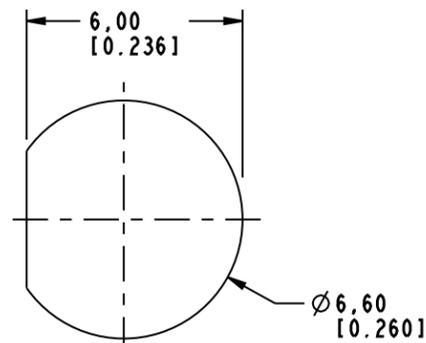
NOTES:

1. MATERIALS AND FINISHES:  
 BODY - BRASS, GOLD PLATING  
 CONTACT - BeCu, GOLD PLATING  
 INSULATOR - PTFE
2. ELECTRICAL:  
 A. IMPEDANCE: 75 OHMS  
 B. FREQUENCY RANGE: DC - 4 GHz  
 C. RETURN LOSS : 30 dB @ 3 GHz  
 D. DIELECTRIC WITHSTANDING VOLTAGE: 1000 VRMS, MIN.  
 E. INSULATION RESISTANCE: 10,000 MEGOHMS MIN
3. MECHANICAL:  
 A. DURABILITY: 500 CYCLES MIN.
4. ENVIRONMENTAL:  
 A. THERMAL SHOCK PER MIL-STD-202 METHOD 107  
 TEST CONDITION B (EXCEPT HIGH TEMP @200°C)  
 B. VIBRATION: MIL-STD-202 METHOD 204 TEST CONDITION B  
 C. SHOCK: MIL-STD-202 METHOD 213 TEST CONDITION B  
 D. CORROSION: MIL-STD-202 METHOD 101  
 TEST CONDITION B 5% SALT SOLUTION
5. AMPHENOL SPANNER WRENCH 227-1490 REQUIRED TO MOUNT CONNECTOR TO PANEL.
6. PACKAGING:  
 A. QUANTITY: SINGLE PACK  
 B. MARKING: BAG TO BE MARKED "AMPHENOLRF, 34-1018 AND DATE CODE"

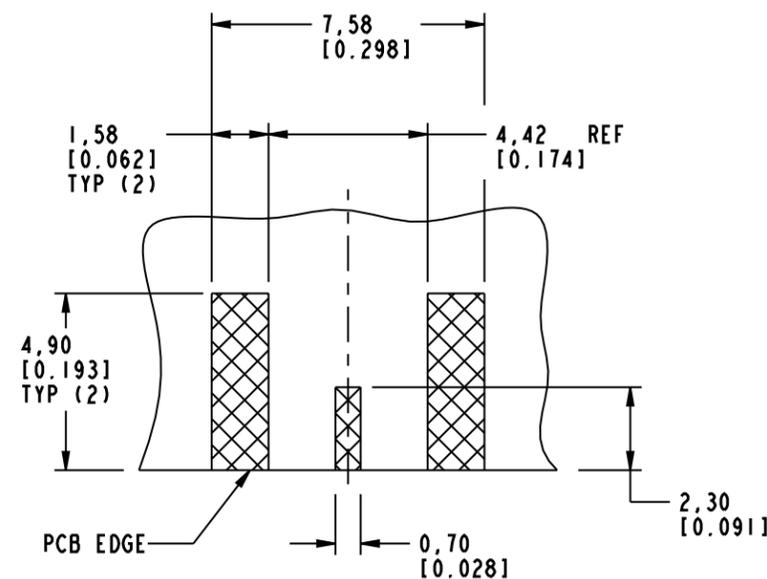
THIRD ANGLE PROJ.

REVISIONS

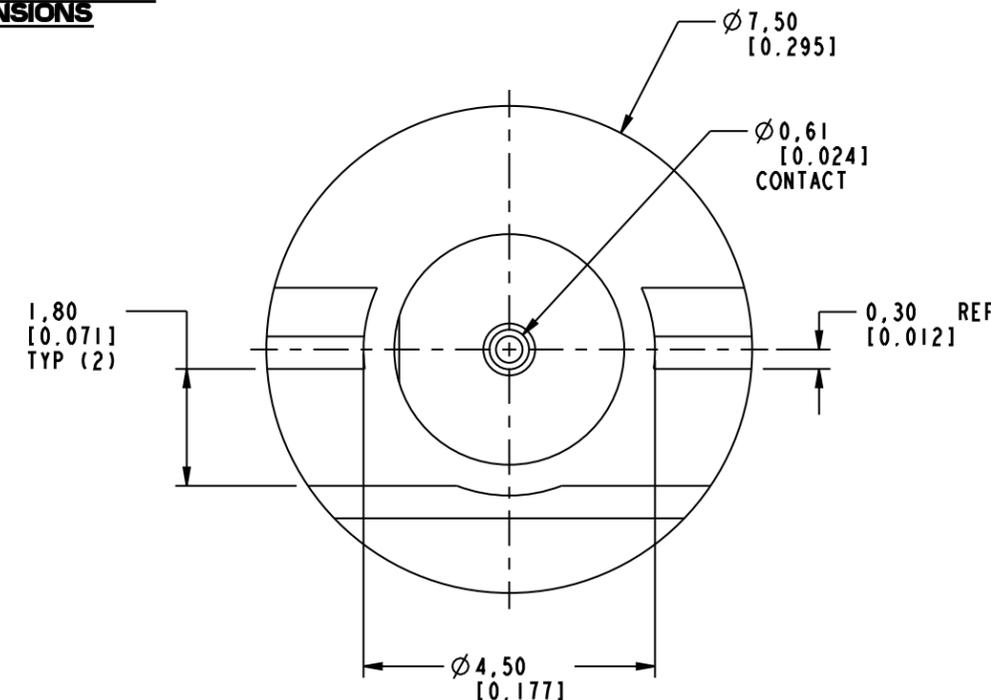
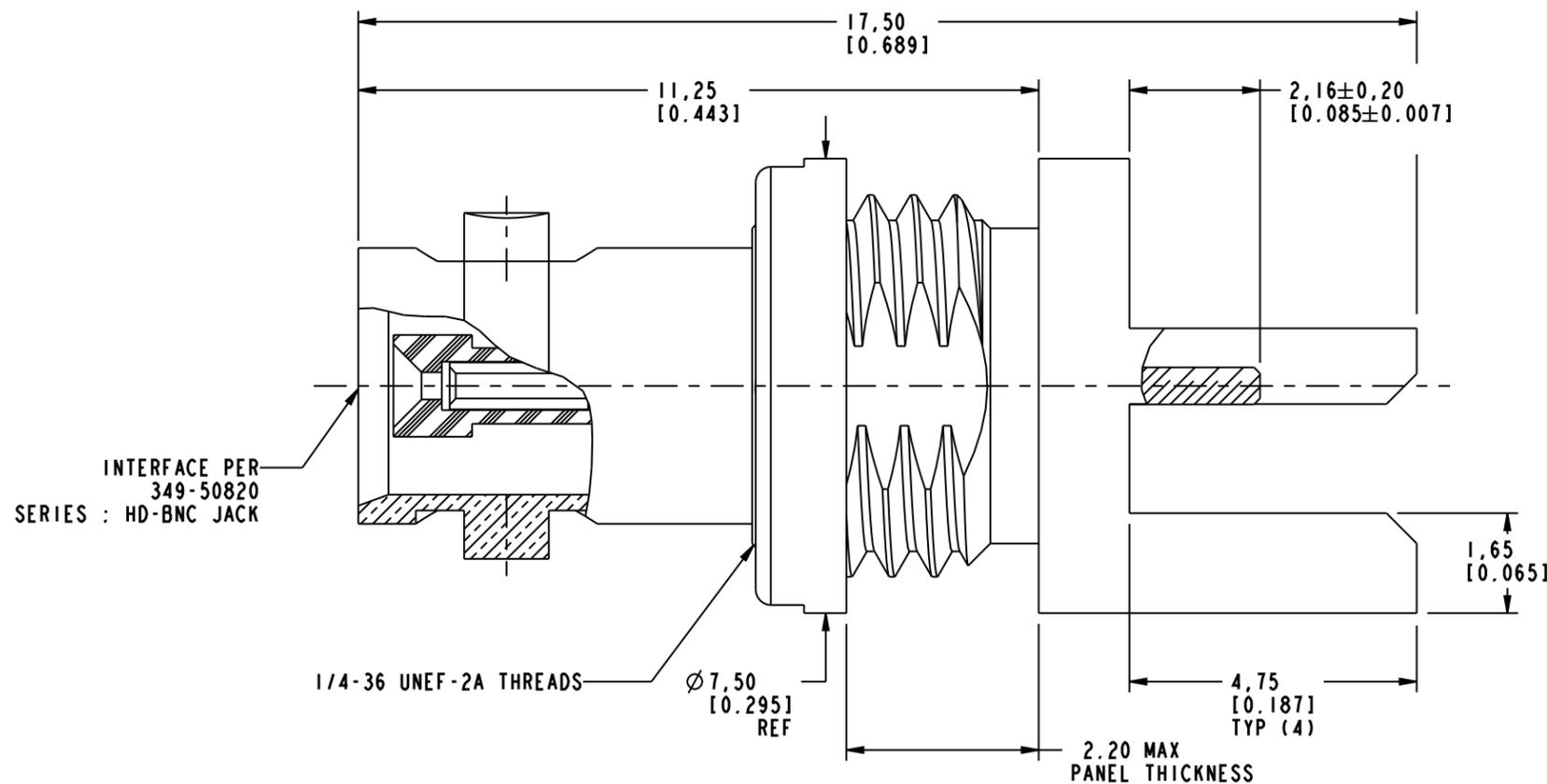
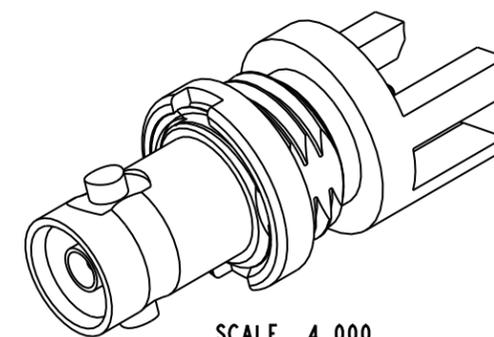
REV	DESCRIPTION	DATE	ECO	APPR
A	RELEASED TO MFG.	--	48167	AAP



**SCALE 5.000**  
**RECOMMENDED MOUNTING HOLE DIMENSIONS**



**SCALE 5.000**  
**RECOMMENDED PCB DIMENSIONS**



**CUSTOMER OUTLINE DRAWING**  
 ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN METRIC AND TOLERANCES ARE:  
 <0.5mm ±0.05mm    0.5 - 6mm ±0.1mm    6 - 30mm ±0.2mm    30 - 120mm ±0.3mm    ANGLES ±1°

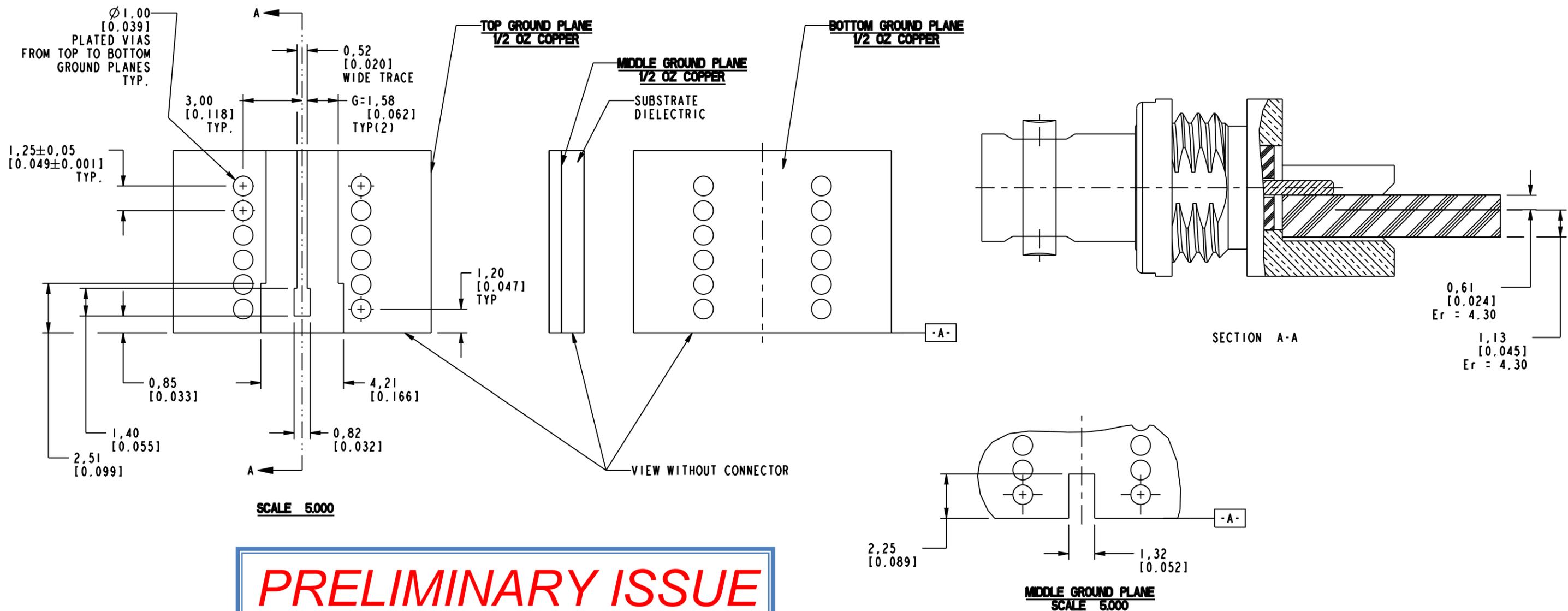
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MATERIAL SEE NOTES	DRAWN PADMANABHAN E	DATE 27-Jan-10	TITLE HD BNC BHD JACK EDGE MOUNT FOR 0.062" THICK BOARD	Amphenol RF Danbury CT USA, Tainan, Taiwan, Shenzhen, China www.amphenolrf.com
REFERENCE EAR # 3896	ENGINEER PADMANABHAN E	DATE 27-Jan-10		
CONFIGURATION LEVEL: Prototype	APPROVED	DATE	SCALE: 9.0:1.0	DRAWING NO. 34-1018
FINISH	CAD FILE Root Folder/HD-BNC/34-1018	DWG SIZE B	SHEET 2 OF 4	ITEM NO. 34-1018
		REV A		PART NO. 34-1018

REV	DESCRIPTION	DATE	ECO	APPR
A	RELEASED TO MFG.	--	48167	AAP

# RECOMMENDED PCB LAUNCH FOR OPTIMAL RF PERFORMANCE

VARIATIONS IN BOARD SUBSTRATE AND TRACE MAY REQUIRE DIFFERENT GEOMETRY



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MATERIAL	
REFERENCE	EAR # 3896
CONFIGURATION LEVEL:	Prototype
FINISH	

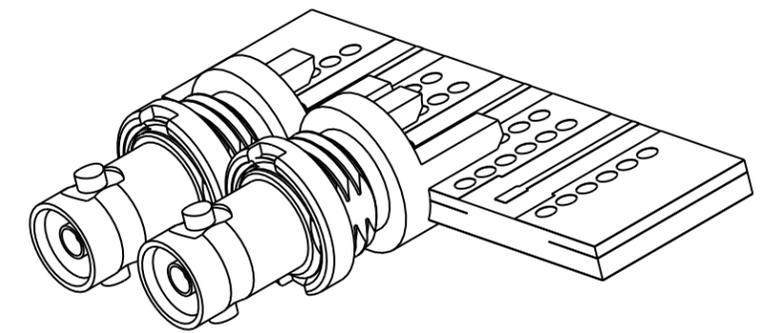
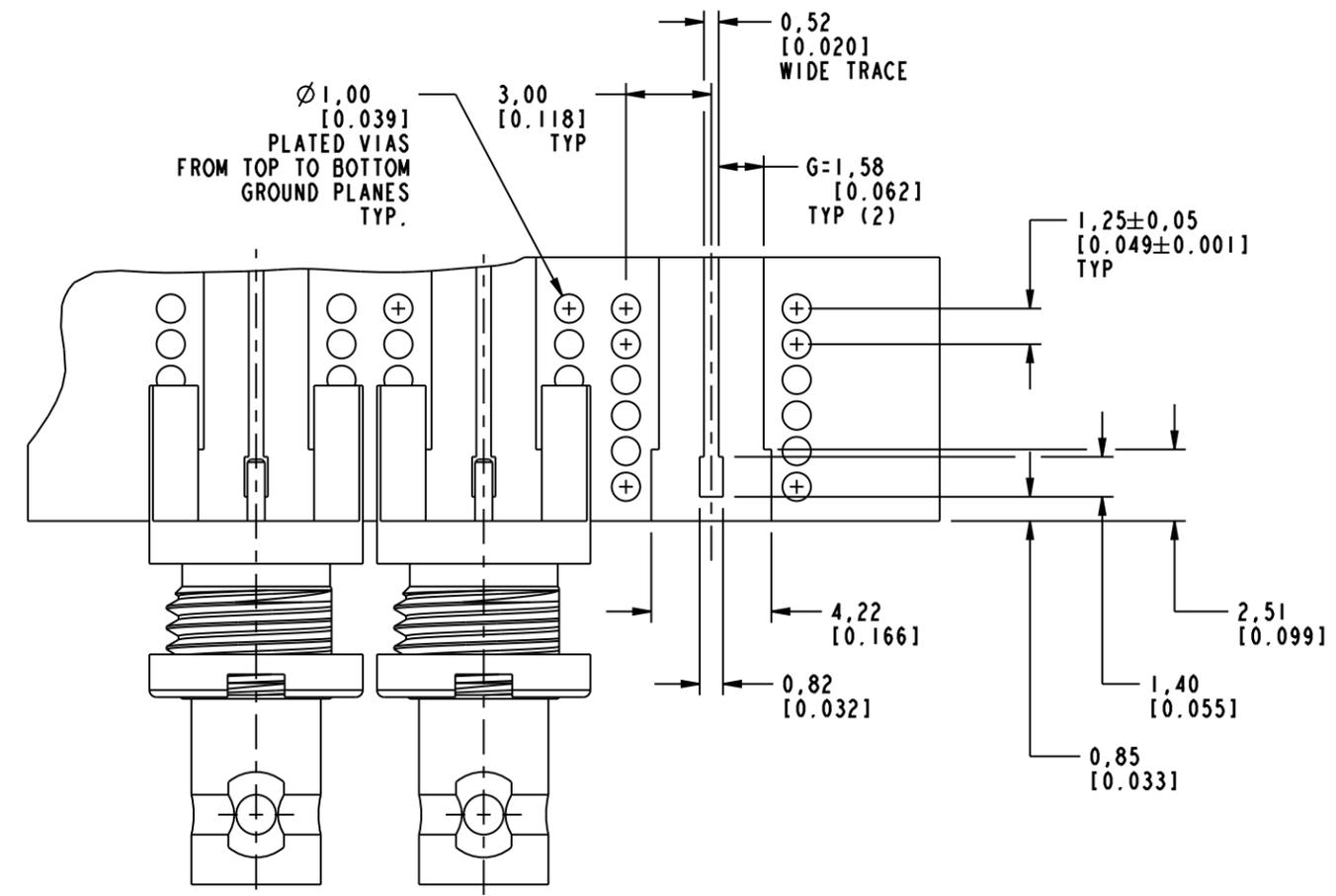
DRAWN	PADMANABHAN E	DATE	25-Jun-10
ENGINEER	PADMANABHAN E	DATE	25-Jun-10
APPROVED		DATE	
CAD FILE	Root Folder/HD-BNC/34-1018		

TITLE		HD BNC BHD JACK	
EDGE MOUNT FOR		0.062" THICK BOARD	
SCALE:	12.0:1.0	SHEET	3 OF 4
DWG SIZE	B	REV	A

Amphenol RF	
Danbury CT USA, Tainan, Taiwan, Shenzhen, China www.amphenolrf.com	
DRAWING NO. 34-1018	
ITEM NO. 34-1018	
PART NO. 34-1018	

THIRD ANGLE PROJ.

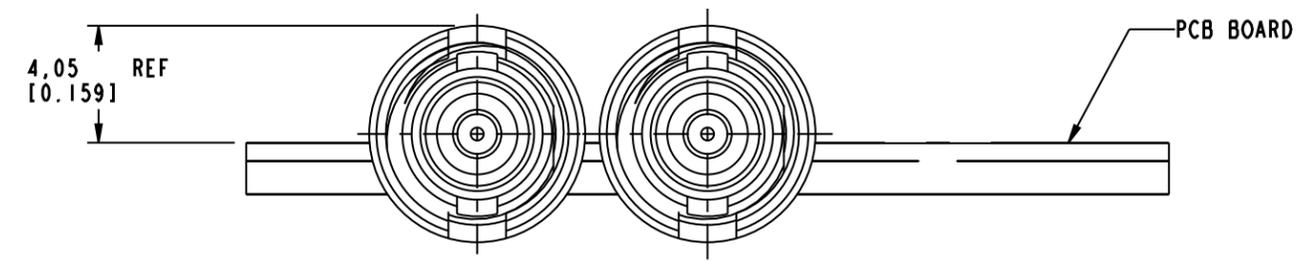
REVISIONS				
REV	DESCRIPTION	DATE	ECO	APPR
A	RELEASED TO MFG.	--	48167	PNE



SCALE 3.000

# RECOMMENDED PCB LAUNCH

CONNECTORS TO BE SPACED AT 8 MM MIN. PITCH.



**PRELIMINARY ISSUE**

**CUSTOMER OUTLINE DRAWING**  
ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY

<p>UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN METRIC AND TOLERANCES ARE:                  &lt;0.5mm ±0.05mm    0.5 - 6mm ±0.1mm    6 - 30mm ±0.2mm    30 - 120mm ±0.3mm    ANGLES ±1°</p> <p>NOTICE - These drawings, specifications, or other data (1) are, and remain the property of Amphenol corp. (2) must be returned upon request; and (3) are confidential and not to be disclosed to any person other than those to whom they are given by Amphenol Corp. The furnishing of these drawings, specifications, or other data by Amphenol Corp., or to any other person to anyone for any purpose is not to be regarded by implication or otherwise in any manner licensing, granting rights to permitting such holder or any other person to manufacture, use or sell any product, process or design, patented or otherwise, that may in any way be related to or disclosed by said drawings, specifications, or other data.</p>	<p>MATERIAL -</p>	<p>DRAWN PADMANABHAN E</p>	<p>DATE 29-Jun-10</p>	<p>TITLE HD BNC BHD JACK EDGE MOUNT FOR 0.062" THICK BOARD</p>	<p>Amphenol RF Danbury CT USA, Tainan, Taiwan, Shenzhen, China www.amphenolrf.com</p>	
	<p>REFERENCE EAR # 3896</p>	<p>ENGINEER PADMANABHAN E</p>	<p>DATE 29-Jun-10</p>			<p>SCALE: 4.0:1.0 SHEET 4 OF 4</p>
	<p>CONFIGURATION LEVEL: Prototype</p>	<p>APPROVED</p>	<p>DATE</p>	<p>DWG SIZE B</p>	<p>REV A</p>	<p>DRAWING NO. 34-1018</p>
	<p>FINISH</p>	<p>Root Folder/HD-BNC/34-1018</p>	<p>DWG SIZE B</p>	<p>REV A</p>	<p>ITEM NO. 34-1018</p>	<p>PART NO. 34-1018</p>

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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